

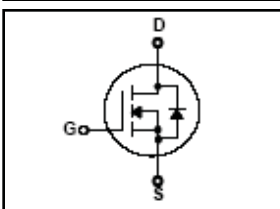
# HFS6N60U

## 600V N-Channel MOSFET

### FEATURES

- Originative New Design
- Superior Avalanche Rugged Technology
- Robust Gate Oxide Technology
- Very Low Intrinsic Capacitances
- Excellent Switching Characteristics
- Unrivalled Gate Charge : 16.0 nC (Typ.)
- Extended Safe Operating Area
- Lower  $R_{DS(ON)}$  : 1.33  $\Omega$  (Typ.) @  $V_{GS}=10V$
- 100% Avalanche Tested

$BV_{DSS} = 600 V$   
 $R_{DS(on) typ} = 1.33 \Omega$   
 $I_D = 6.0 A$



### Absolute Maximum Ratings $T_C=25^\circ C$ unless otherwise specified

Symbol	Parameter	Value	Units
$V_{DSS}$	Drain-Source Voltage	600	V
$I_D$	Drain Current – Continuous ( $T_C = 25^\circ C$ )	6.0 *	A
	Drain Current – Continuous ( $T_C = 100^\circ C$ )	3.8 *	A
$I_{DM}$	Drain Current – Pulsed (Note 1)	24.0*	A
$V_{GS}$	Gate-Source Voltage	$\pm 30$	V
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	170	mJ
$I_{AR}$	Avalanche Current (Note 1)	6.0	A
$E_{AR}$	Repetitive Avalanche Energy (Note 1)	5.4	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	4.5	V/ns
$P_D$	Power Dissipation ( $T_C = 25^\circ C$ ) - Derate above $25^\circ C$	54	W
		0.43	W/ $^\circ C$
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	$^\circ C$
$T_L$	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	$^\circ C$

\* Drain current limited by maximum junction temperature

### Thermal Resistance Characteristics

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	--	2.33	$^\circ C/W$
$R_{\theta JA}$	Junction-to-Ambient	--	62.5	

## Package Marking and Odering Information

Device Marking	Week Marking	Package	Packing	Quantity	RoHS Status
HFS6N60U	YWWX	TO-220F(A)	Tube	50	Pb Free
HFS6N60US	YWWX	TO-220F(B)	Tube	50	Pb Free
HFS6N60U	YWWXg	TO-220F(A)	Tube	50	Halogen Free
HFS6N60US	YWWXg	TO-220F(B)	Tube	50	Halogen Free

※ TO-220F(A) : Dual Gauge, TO-220F(B) : Single Gauge

## Electrical Characteristics $T_C=25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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### On Characteristics

$V_{GS}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	2.5	--	4.5	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, I_D = 3.0 \text{ A}$	--	1.33	1.66	$\Omega$

### Off Characteristics

$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	600	--	--	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$ , Referenced to $25^\circ\text{C}$	--	0.6	--	$\text{V}/^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 480 \text{ V}, T_C = 125^\circ\text{C}$	--	--	1 10	$\mu\text{A}$ $\mu\text{A}$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$	--	--	$\pm 100$	nA

### Dynamic Characteristics

$C_{iss}$	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ $f = 1.0 \text{ MHz}$	--	870	1130	pF
$C_{oss}$	Output Capacitance		--	80	105	pF
$C_{rss}$	Reverse Transfer Capacitance		--	10	13	pF

### Switching Characteristics

$t_{d(on)}$	Turn-On Time	$V_{DS} = 300 \text{ V}, I_D = 6.0 \text{ A},$ $R_G = 25 \Omega$  (Note 4,5)	--	30	60	ns
$t_r$	Turn-On Rise Time		--	40	80	ns
$t_{d(off)}$	Turn-Off Delay Time		--	80	160	ns
$t_f$	Turn-Off Fall Time		--	40	80	ns
$Q_g$	Total Gate Charge	$V_{DS} = 480 \text{ V}, I_D = 6.0 \text{ A},$ $V_{GS} = 10 \text{ V}$  (Note 4,5)	--	16.0	21.0	nC
$Q_{gs}$	Gate-Source Charge		--	5.0	--	nC
$Q_{gd}$	Gate-Drain Charge		--	4.5	--	nC

### Source-Drain Diode Maximum Ratings and Characteristics

$I_S$	Continuous Source-Drain Diode Forward Current	--	--	6.0	A	
$I_{SM}$	Pulsed Source-Drain Diode Forward Current	--	--	24		
$V_{SD}$	Source-Drain Diode Forward Voltage	$I_S = 6.0 \text{ A}, V_{GS} = 0 \text{ V}$	--	--	1.4	V
$t_{rr}$	Reverse Recovery Time	$I_S = 6.0 \text{ A}, V_{GS} = 0 \text{ V}$ $di_F/dt = 100 \text{ A}/\mu\text{s}$ (Note 4)	--	275	--	ns
$Q_{rr}$	Reverse Recovery Charge		--	2.1	--	$\mu\text{C}$

#### Notes ;

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2.  $L=8.7\text{mH}$ ,  $I_{AS}=6.0\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$
3.  $I_{SD}\leq 6.0\text{A}$ ,  $di/dt\leq 200\text{A}/\mu\text{s}$ ,  $V_{DD}\leq BV_{DSS}$ , Starting  $T_J=25^\circ\text{C}$
4. Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$
5. Essentially Independent of Operating Temperature

# Typical Characteristics

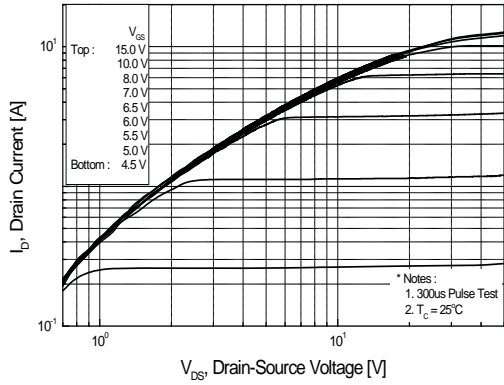


Figure 1. On Region Characteristics

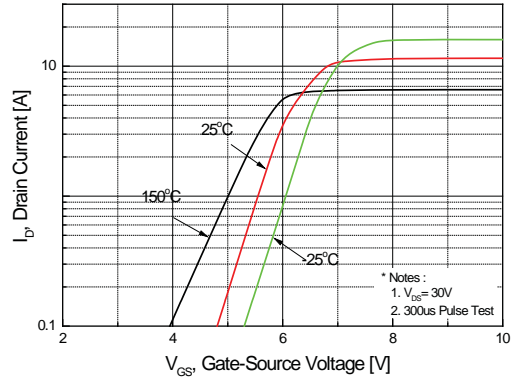


Figure 2. Transfer Characteristics

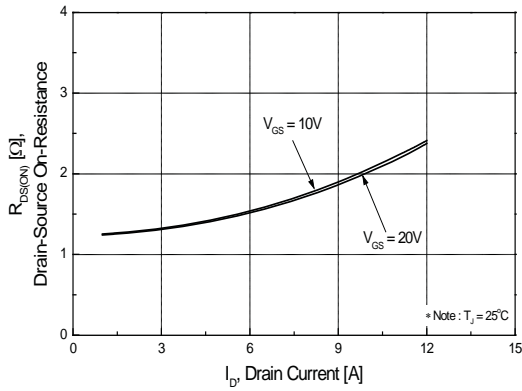


Figure 3. On Resistance Variation vs Drain Current and Gate Voltage

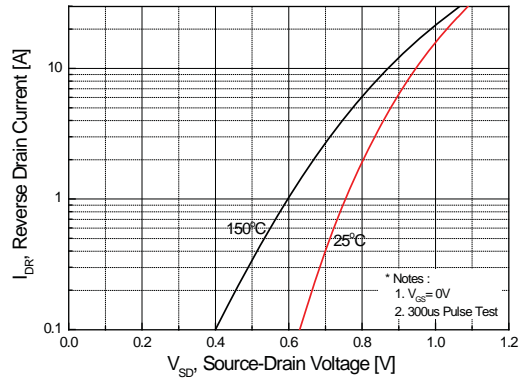


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

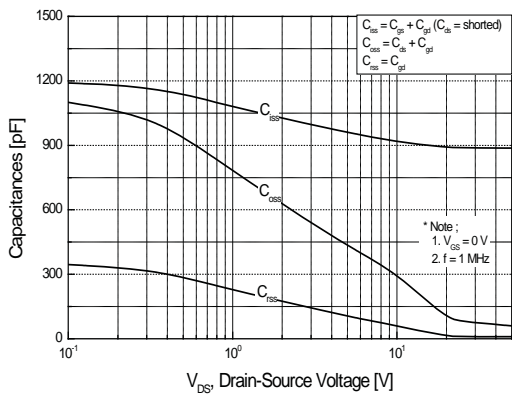


Figure 5. Capacitance Characteristics

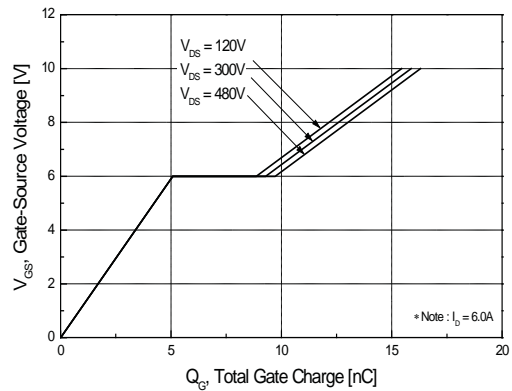
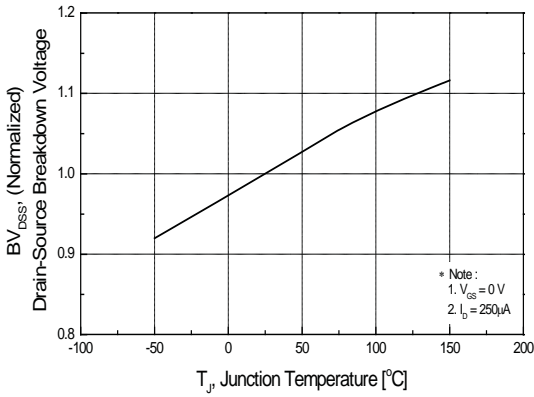
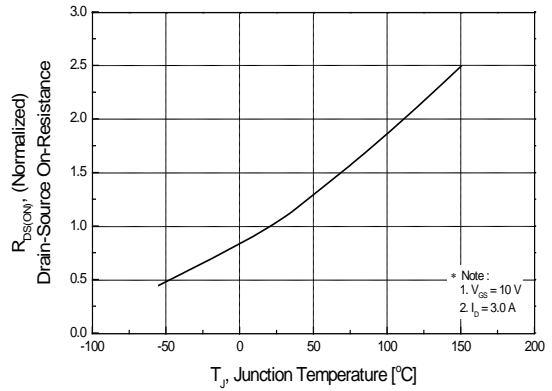


Figure 6. Gate Charge Characteristics

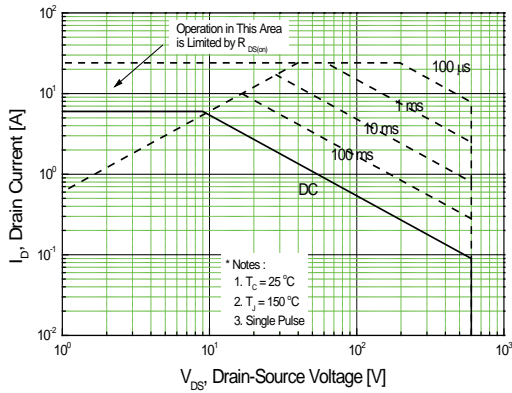
**Typical Characteristics (continued)**



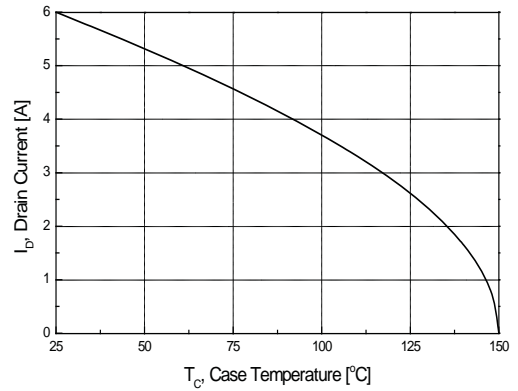
**Figure 7. Breakdown Voltage Variation vs Temperature**



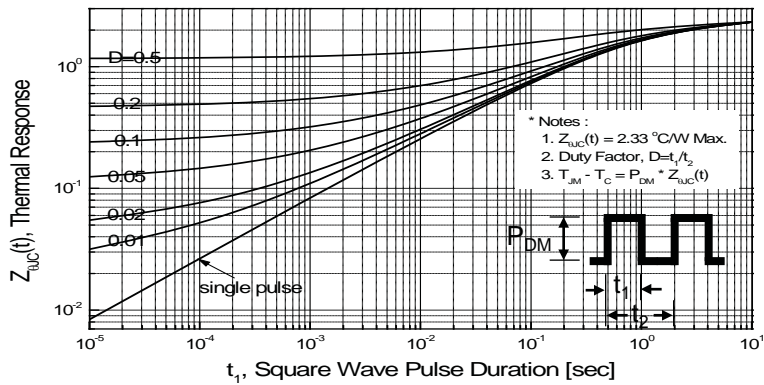
**Figure 8. On-Resistance Variation vs Temperature**



**Figure 9. Maximum Safe Operating Area**



**Figure 10. Maximum Drain Current vs Case Temperature**



**Figure 11. Transient Thermal Response Curve**

Fig 12. Gate Charge Test Circuit & Waveform



Fig 13. Resistive Switching Test Circuit & Waveforms

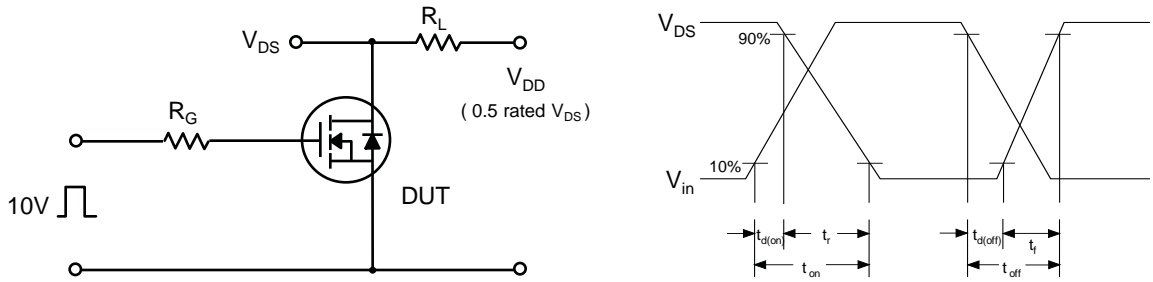


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

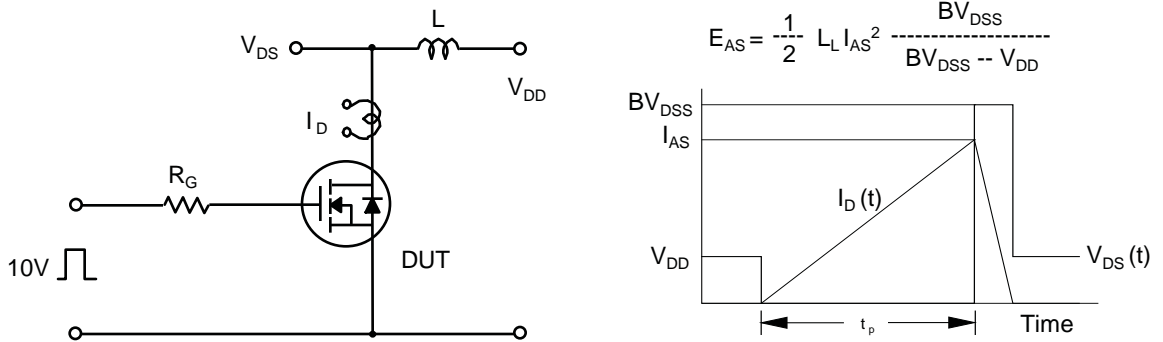
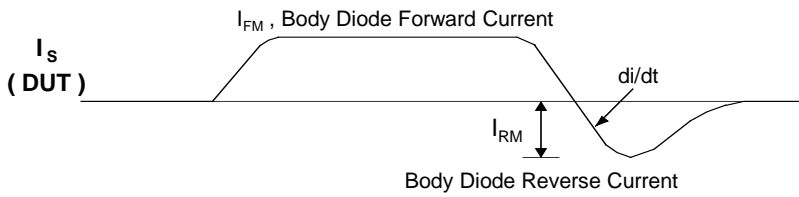
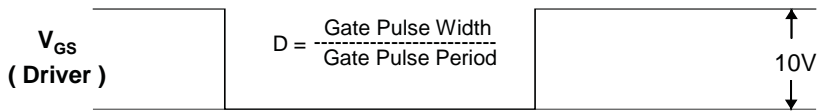
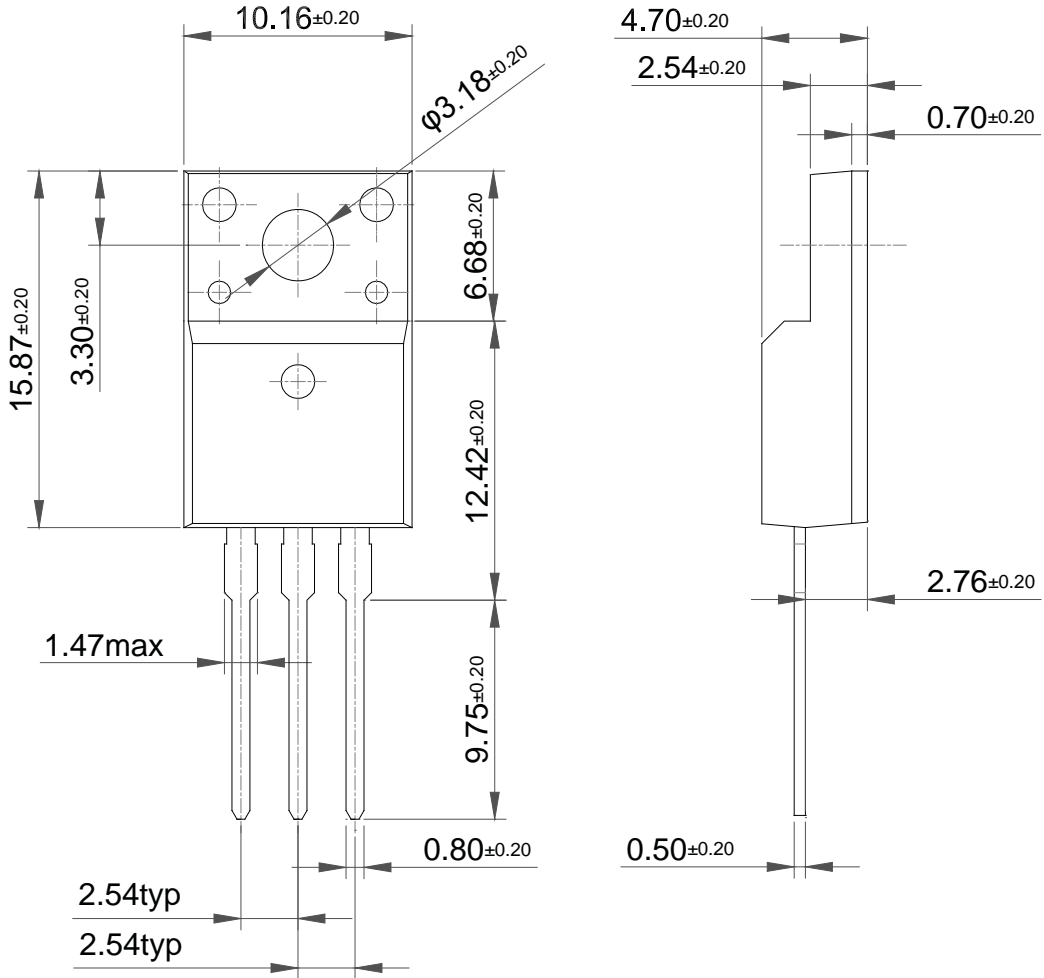


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



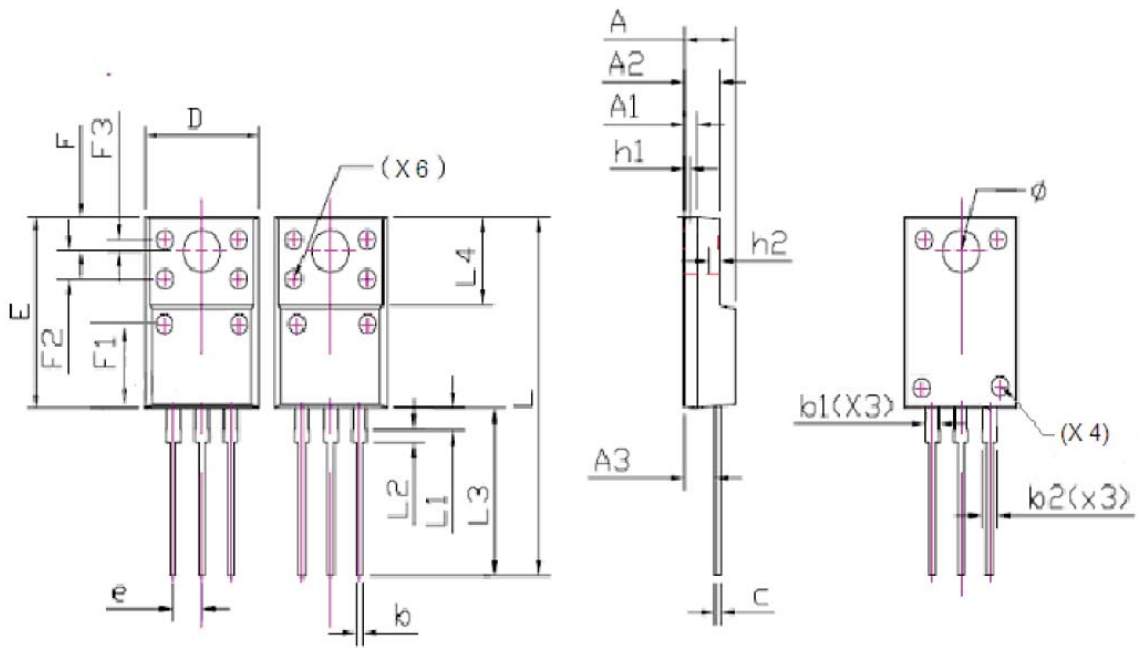
Package Dimension

TO-220F (A)



## Package Dimension

## TO-220F (B)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.300	4.700	0.169	0.185
A1	1.300 REF.		0.051 REF.	
A2	2.800	3.300	0.110	0.130
A3	2.500	2.900	0.098	0.114
b	0.500	0.750	0.020	0.030
b1	1.150	1.300	0.045	0.051
b2	1.150	1.400	0.045	0.055
c	0.500	0.750	0.020	0.030
D	9.900	10.360	0.390	0.408
E	14.800	15.200	0.583	0.598
e	2.540 TYP.		0.100 TYP.	
F	2.700 REF.		0.106 REF.	
F1	6.300 REF.		0.248 REF.	
F2	2.200 REF.		0.087 REF.	
F3	0.900 REF.		0.035 REF.	
Φ	3.200	3.500	0.126	0.138
h1	0.500 REF.		0.020 REF.	
h2	0.800 REF.		0.031 REF.	
L	28.000	29.000	1.102	1.142
L1	1.400	1.800	0.055	0.071
L2	1.200	2.000	0.047	0.079
L3	13.0	13.8	0.512	0.543
L4	7.000 REF.		0.276 REF.	